

PATENT ABSTRACTS OF JAPAN

(11)Publication number : 11-071474 (b)

(43)Date of publication of application : 16.03.1999

(51)Int.Cl. C08J 5/18
// C08J 7/00
C08J 7/12
C08L 79:08

(21)Application number : 10-187576

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(22)Date of filing : 02.07.1998

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(30)Priority

Priority number : 09180022 Priority date : 04.07.1997 Priority country : JP

(54) POLYIMIDE FILM AND PREPARATION THEREOF

(57)Abstract:

PROBLEM TO BE SOLVED: To provide a polyimide film with improved durability of adhesion strength against a high temperature, high humidity environment without adversely affecting the external appearance of the polyimide film to be used as a base film of flexible printed circuit boards.

SOLUTION: The surface of a partially cured or partially dried polyamic acid film having an imidation ratio of not less than 50% is coated with a solution of an organic titanium compound or a partially cured or partially dried polyamic acid film having an imidation ratio of not less than 50% is impregnated with a solution of a titanium compound and then, the polyamic acid film is converted into a polyimide film which is then dried. As a result, in the surface of this polyimide film are introduced titanium atoms at a concentration of the number of atoms of 0.01%-10% measured by X-ray photoelectron spectroscopy and thus, the polyimide film is improved in the durability of adhesion strength against a high temperature, high humidity environment without spoiling the external appearance of the film.

LEGAL STATUS

[Date of request for examination] 29.01.2003

[Date of sending the examiner's decision of rejection] 21.12.2004

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number]

[Date of registration]

[Number of appeal against examiner's decision] 2005-01313

of rejection]

[Date of requesting appeal against examiner's decision of rejection] 20.01.2005

[Date of extinction of right]

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